## Supporting information

## Silver nanowires intercalating $Ti_3C_2T_x$ MXene composite films with excellent

## flexibility for electromagnetic interference shielding

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Fig. S1 Size dispersion (a) and AFM image (b) of  $Ti_3C_2T_x$  sheets. Size dispersion was calculated from TEM image.



Fig. S2 Surface and cross-sectional SEM images of AgNWs-NC (a,c) and  $Ti_3C_2$ -NC (b,d) hybrid films, respectively.



Fig. S3 SEM images of top surfaces and fracture surfaces for (a, b) TN0.125A, (c, d) TN0.25A and (e, f) TN0.5A.



Fig. S4 EMI SE of TN0.167A,  $Ti_3C_2$ -NC and AgNWs-NC hybrid films in the frequency range of 8.2-12.4 GHz.



Fig. S5  $SE_R/SE_A$  and  $SE_R/SE_T$  values of pure  $Ti_3C_2$  and hybrid films as the ratio of NC-to- $Ti_3C_2$ .

Commla	Meteriale	Content	Not	Thickness	Density	EMI SE	SSE	SSE/t	Dof
Sample	Waterials	(wt%)	Iviauix	(cm)	(g·cm <sup>-3</sup> )	(dB)	$(cm^{3} \cdot g^{-1})$	$(cm^{2} \cdot g^{-1})$	
1	Ni fiber/PES	7*	PES	0.285	1.87	58	31	108.7	1
2	Ni filaments/PES	7*	PES	0.285	1.85	87	47	164.9	1
3	copper	Bulk	/	0.31	9	90	10	32.3	1
4	CuNi-CNT foam	Bulk	/	0.15	0.23	54.6	237	1580	2
5	SWCNT/PS	7	PS	0.12	0.56	18.5	33	275	3
6	MWCNT/WPU	76.2	WPU	0.1	0.039	21.1	541	5410	4
7	CNT sponge	Bulk	/	0.238	0.02	22	1100	4622	5
8	CNT/Epoxy	0.66	Epoxy	0.2	0.975	33	33.84	169.2	6
9	CNT/Cellulose	40	cellulose	0.015	1.7	35	20.586	1372.4	7
10	RGO foam	Bulk	/	0.03	0.06	25.2	420	14000	8
11	Graphene paper	Bulk	/	0.005	0.81	62	76.5	15309	9
12	Fe <sub>3</sub> O <sub>4</sub> /Graphene paper	Bulk	/	0.03	0.78	24	30.76	1025	10
13	Graphene/PDMS foam	0.8	PDMS	0.1	0.06	19.98	333	3330	11
14	Graphene foam/PEDOT:PSS	40	PEDOT: PSS	0.15	0.0198	69.1	3124	20827	12
15	CNT/graphene foam	Bulk	/	0.16	0.0058	38.4	6620	41375	13
16	Ti <sub>3</sub> C <sub>2</sub> foam	Bulk	/	0.006	0.22	70	318	53030	14
17	Ti <sub>3</sub> C <sub>2</sub> /SA	90	SA	0.0008	2.317	57	24.6	30830	15
18	Ti <sub>3</sub> C <sub>2</sub>	Bulk	/	0.0011	2.394	68	28.4	25863	15
19	Ti <sub>3</sub> C <sub>2</sub> /CNF	90	cellulose	0.0047	2	24	12	2647	16
20	Ti <sub>3</sub> C <sub>2</sub> T <sub>x</sub> / TOCNF	50	cellulose	0.0047	1.46	32.7	22.4	4761	17
21	CNF@MXene	50	cellulose	0.0035	/	40	/	7029	18
22	d-Ti <sub>3</sub> C <sub>2</sub> T <sub>x</sub> /ANF	60	Aramid Nanofibe	0.0017	1.255	28.54	22.74	13377	19
23	MXene-GO	50	GO	0.0007	/	50.17	/	/	20
24	Ti <sub>3</sub> C <sub>2</sub> T <sub>x</sub> / PEDOT: PSS	87.5	PEDOT: PSS	0.0011	1.94	42.1	21.7	19497.8	21
25	MXene film	Bulk	/	0.0009	2.165	42.78	19.76	21953	
26	MXene/AgNW film	86	Nanocell ulose	0.0017	1.5	42.74	28.49	16724	work

Table S1 Comparison of EMI shielding performance for various materials

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